TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHCT125AF,TC74VHCT125AFN,TC74VHCT125AFT,TC74VHCT125AFK TC74VHCT126AF,TC74VHCT126AFN,TC74VHCT126AFT,TC74VHCT126AFK

TC74VHCT125AF/AFN/AFT/AFK Quad Bus Buffer TC74VHCT126AF/AFN/AFT/AFK Quad Bus Buffer

The TC74VHCT125A/126A are high speed CMOS QUAD BUS BUFFERs fabricated with silicon gate C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Shottky TTL while maintaining the CMOS low power dissipation.

The TC74VHCT125A requires the 3-state control input  $\overline{G}$  to be set high to place the output into the high impedance state, whereas the TC74VHCT126A requires the control input G to be set low to place the output into high impedance.

The input voltage are compatible with TTL output voltage. This device may be used as a level converter for interfacing  $3.3\ V$  to  $5\ V$  system.

Input protection and output circuit ensure that 0 to 5.5~V can be applied to the input and output  $^{\rm (Note)}$  pins without regard to the supply voltage. There structure prevents device detsruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

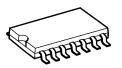
Note:  $V_{CC} = 0 V$ 

#### **Features**

- High speed: tpd = 3.8 ns (typ.) at VCC = 5 V
- Low power dissipation:  $I_{CC} = 4 \mu A$  (max) at  $T_a = 25$ °C
- Compatible with TTL inputs:  $V_{IL} = 0.8 \text{ V (max)}$  $V_{IH} = 2.0 \text{ V (min)}$
- Power down protection is provided on all inputs and outputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with the 74 series (74AC/HC/F/ALS/LS etc.) 125/126 types.

Note: xxxFN (JEDEC SOP) is not available in Japan.

TC74VHCT125AF, TC74VHCT126AF



SOP14-P-300-1.27A TC74VHCT125AFN, TC74VHCT126AFN



SOL14-P-150-1.27 TC74VHCT125AFT, TC74VHCT126AFT



TSSOP14-P-0044-0.65A TC74VHCT125AFK, TC74VHCT126AFK



VSSOP14-P-0030-0.50

Weight

 SOP14-P-300-1.27A:
 0.18 g (typ.)

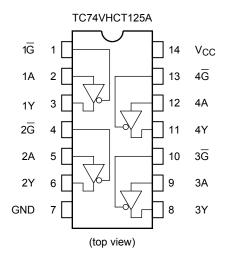
 SOL14-P-150-1.27:
 0.12 g (typ.)

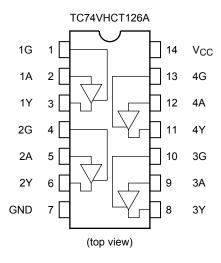
 TSSOP14-P-0044-0.65A:
 0.06 g (typ.)

 VSSOP14-P-0030-0.50:
 0.02 g (typ.)

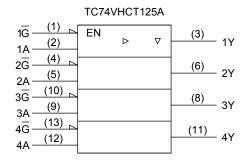


### **Pin Assignment**





# **IEC Logic Symbol**



	TC74VHCT126A									
1G - 1A - 2G - 2A - 3G - 3A - 4G -	(1) (2) (4) (5) (10) (9) (13) (12)	EN	D	∇	(3) 1Y (6) 2Y (8) 3Y (11) 4Y					

### **Truth Table**

#### TC74VHCT125A

Inp	uts	Output		
IG	Α	Y		
Н	Х	Z		
L	L	L		
L	Н	Н		

X: Don't care

Z: High impedance

#### TC74VHCT126A

Inp	uts	Output
G	Α	Y
L	Х	Z
Н	L	L
Н	Н	Н

X: Don't care

2

Z: High impedance



### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V	-0.5 to 7.0 (Note 2)	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	
Input diode current	lıĸ	-20	mA
Output diode current	lok	±20 (Note 4)	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in off-state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

### **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V	0 to 5.5 (Note 2)	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub> (Note 3)	V
Operating temperature	T <sub>opr</sub>	–40 to 85	°C
Input rise and fall time	dt/dv	0 to 20	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 2: Output in off-state

Note 3: High or low state



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol Test C		ondition		Ta = 25°C			Ta = -40 to 85°C		Unit
	.,			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>	_		4.5 to 5.5	2.0	_	_	2.0	_	V
Low-level input voltage	V <sub>IL</sub>	_	-	4.5 to 5.5		_	0.8	_	0.8	V
High-level output	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	4.5	4.40	4.50	_	4.40		V
voltage		AIN = AIH OL AIL	$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80		V
Low-level output	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 50 \mu A$	4.5		0.0	0.1	_	0.1	V
voltage			$I_{OL} = 8 \text{ mA}$	4.5		_	0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5		_	±0.1	_	±1.0	μА
3-state output off-state current	l <sub>OZ</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND			_	±0.25		±2.50	μΑ
	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5		_	4.0	_	40.0	μА
Quiescent supply current	ICCT	Per input: $V_{IN} = 3.4 \text{ V}$ Other input: $V_{CC}$ or GND		5.5			1.35	_	1.50	mA
Output leakage current	I <sub>OPD</sub>	V <sub>OUT</sub> = 5.5 V		0	_	_	0.5		5.0	μА

### AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Tes	Test Condition Ta = 2				Ta = 25°C		Ta = -40 to 85°C	
	,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
Propagation delay	t <sub>pLH</sub>		5.0 ± 0.5	15	_	3.8	5.5	1.0	6.5	ns
time	$t_{pHL}$	_	3.0 ± 0.3	50	_	5.3	7.5	1.0	8.5	
Output anable time	t <sub>pZL</sub>	D: 110	5.0 ± 0.5	15	_	3.6	5.1	1.0	6.0	20
Output enable time	$t_{pZH}$	$R_L = 1 k\Omega$		50	_	5.1	7.1	1.0	8.0	ns
Output disable time	t <sub>pLZ</sub>	$R_L = 1 \text{ k}\Omega$	5.0 ± 0.5	50	_	6.1	8.8	1.0	10.0	ns
Output disable time	t <sub>pHZ</sub>									115
Output to output skew	t <sub>osLH</sub>	(Note 1)	5.0 ± 0.5	50	_	_	1.0	_	1.0	ns
Cutput to output show	t <sub>osHL</sub>	(14010-1)	0.0 ± 0.0	00			1.0		1.0	110
Input capacitance	$C_{IN}$		_		_	4	10	_	10	pF
Output capacitance C <sub>OUT</sub>			_		_	6	_	_	_	pF
Power dissipation	C <sub>PD</sub>	TC74VHCT125	5A		_	14	_	_		ηE
capacitance	(Note 2)	TC74VHCT126	SA	_	15	_	_	_	pF	

Note 1: Parameter guaranteed by design.

$$t_{\text{OSLH}} = |t_{\text{pLHm}} - t_{\text{pLHn}}|, \, t_{\text{OSHL}} = |t_{\text{pHLm}} - t_{\text{pHLn}}|$$

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per gate)}$$

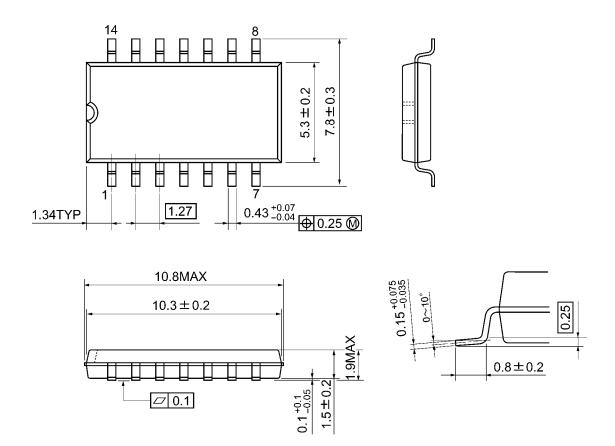


# Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta =	Unit	
Characteristics	Symbol	rest Condition	V <sub>CC</sub> (V)	Тур.	Limit	Offic
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.5	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.5	-0.8	V
Minimum high level dynamic input voltage	$V_{IHD}$	C <sub>L</sub> = 50 pF	5.0	_	2.0	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	0.8	V

# **Package Dimensions**

SOP14-P-300-1.27A Unit: mm

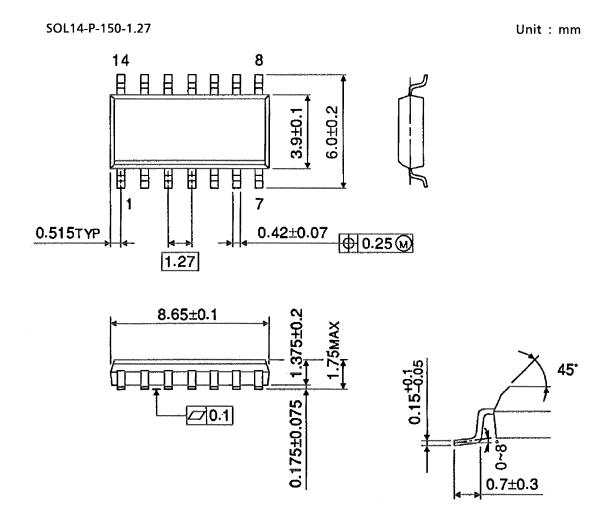


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Weight: 0.18 g (typ.)



# **Package Dimensions (Note)**



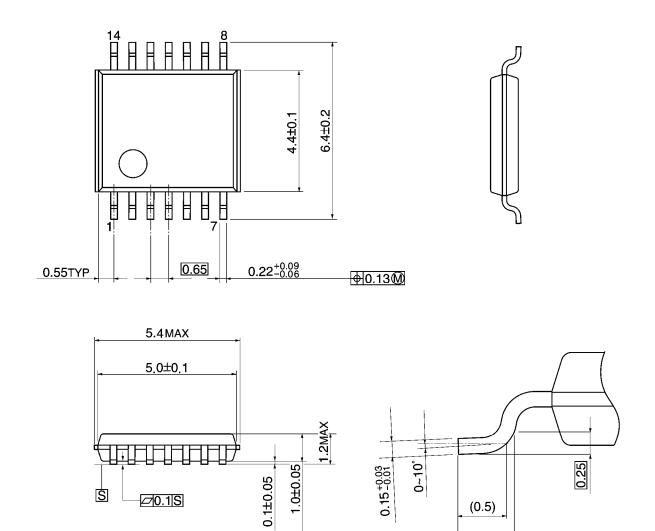
Note: This package is not available in Japan.

Weight: 0.12 g (typ.)

# **Package Dimensions**

TSSOP14-P-0044-0.65A

Unit: mm



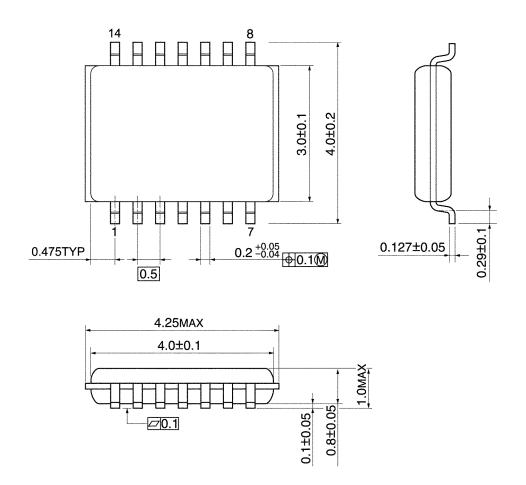
8

Weight: 0.06 g (typ.)

0.45~0.75

# **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



9

Weight: 0.02 g (typ.)



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